

## Small signal Schottky diodes

### Features

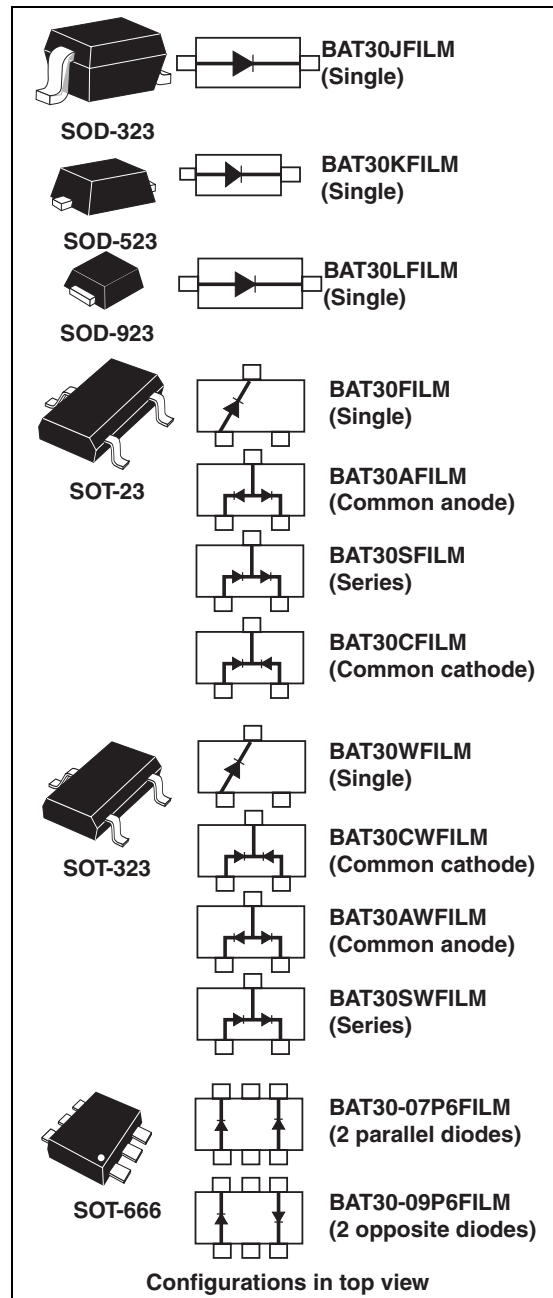
- Very low conduction losses
- Negligible switching losses
- Low forward and reverse recovery times
- Extremely fast switching
- Surface mount device
- Low capacitance diode

### Description

The BAT30 series uses 30 V Schottky barrier diodes encapsulated in a wide range of packages such as SOD-323, SOD-523, SOD-923, SOT-23, SOT-323, or SOT-666. This device is specially suited for switching mode applications needing low forward voltage drop diodes.

**Table 1. Device summary**

Symbol	Value
$I_F$	300 mA
$V_{RRM}$	30 V
$C(\text{typ})$	14 pF
$T_j(\text{max})$	150 °C



# 1 Characteristics

**Table 2. Absolute ratings (limiting values at  $T_j = 25^\circ\text{C}$ , unless otherwise specified)**

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	30	V
$I_F$	Continuous forward current	300	mA
$I_{FSM}$	Surge non repetitive forward current $t_p = 10\text{ ms}$ Sinusoidal	1	A
$T_{stg}$	Storage temperature range	-65 to +150	$^\circ\text{C}$
$T_j$	Maximum operating junction temperature <sup>(1)</sup>	150	$^\circ\text{C}$
$T_L$	Maximum soldering temperature	260	$^\circ\text{C}$

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

**Table 3. Thermal parameters**

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient <sup>(1)</sup>	SOT-23	500
		SOT-323, SOD-323,	550
		SOD-523, SOT-666	600
		SOD-923	900
			$^\circ\text{C/W}$

1. On epoxy printed circuit board with recommended pad layout

**Table 4. Static electrical characteristics**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit	
$I_R^{(1)}$	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = 5\text{ V}$	-	-	0.5	$\mu\text{A}$
			$V_R = 10\text{ V}$	-	-	1	
			$V_R = 25\text{ V}$	-	0.65	3	
			$V_R = 30\text{ V}$	-	-	5	
		$T_j = 70^\circ\text{C}$	$V_R = 10\text{ V}$	-	7	20	
		$T_j = 85^\circ\text{C}$	$V_R = 10\text{ V}$	-	18	50	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 0.1\text{ mA}$	-	-	240	mV
			$I_F = 1\text{ mA}$	-	-	300	
			$I_F = 10\text{ mA}$	-	-	375	
			$I_F = 30\text{ mA}$	-	-	430	
			$I_F = 100\text{ mA}$	-	-	500	
			$I_F = 200\text{ mA}$	-	-	580	
			$I_F = 300\text{ mA}$	-	530	-	

1. Pulse test:  $t_p = 5\text{ ms}$ ,  $\delta < 2\%$

2. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2\%$

Table 5. Dynamic characteristics

Symbol	Parameter	Test conditions	Min.	Typ	Max.	Unit
C	Diode capacitance	$V_R = 0 \text{ V}, F = 1 \text{ MHz}$	-	22	-	pF
		$V_R = 1 \text{ V}, F = 1 \text{ MHz}$	-	14	-	
		$V_R = 10 \text{ V}, F = 1 \text{ MHz}$	-	6	-	

Figure 1. Power dissipation versus average forward current

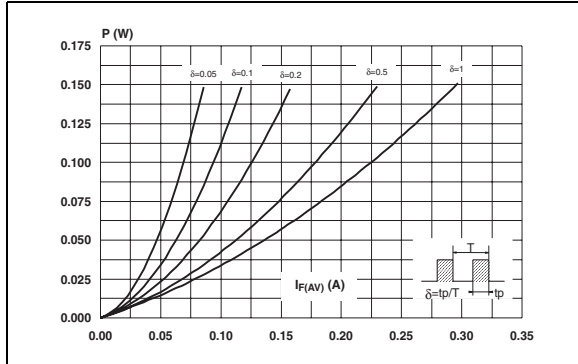


Figure 2. Average forward current versus ambient temperature ( $\delta = 1$ )

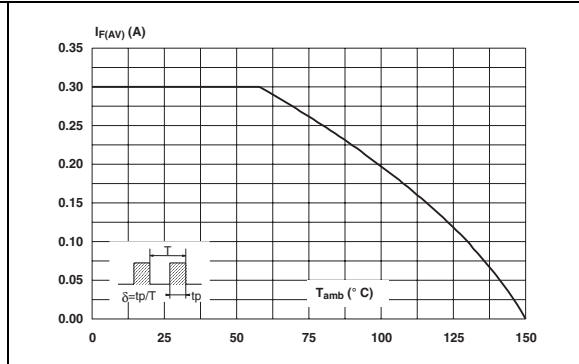


Figure 3. Relative variation of thermal impedance junction to ambient versus pulse duration

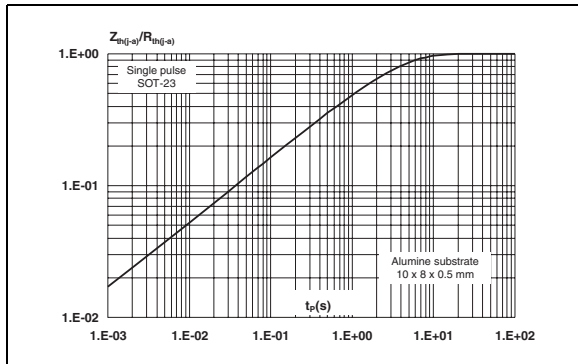
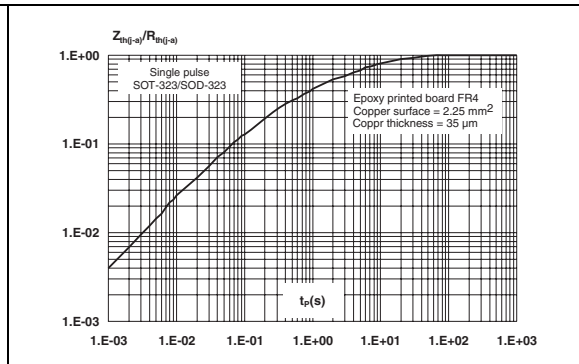
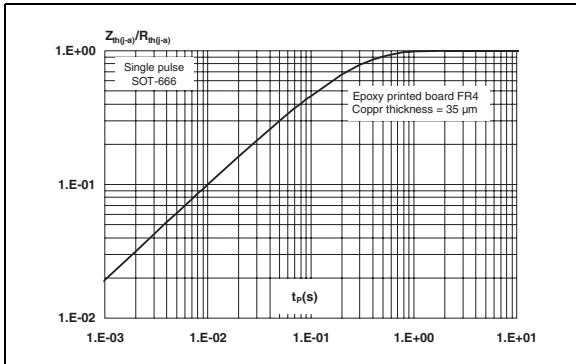


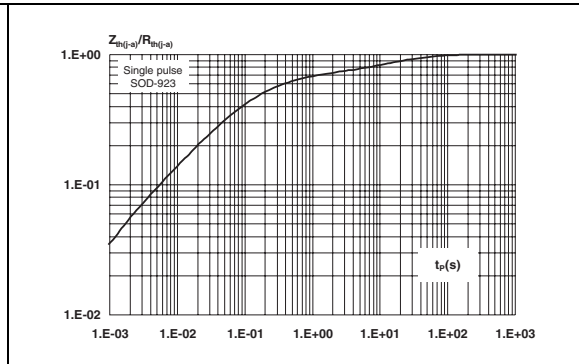
Figure 4. Relative variation of thermal impedance junction to ambient versus pulse duration



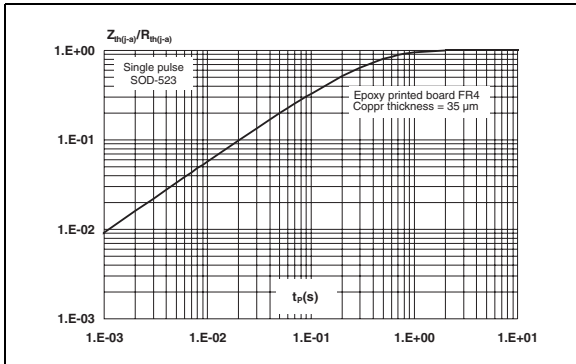
**Figure 5. Relative variation of thermal impedance junction to ambient versus pulse duration**



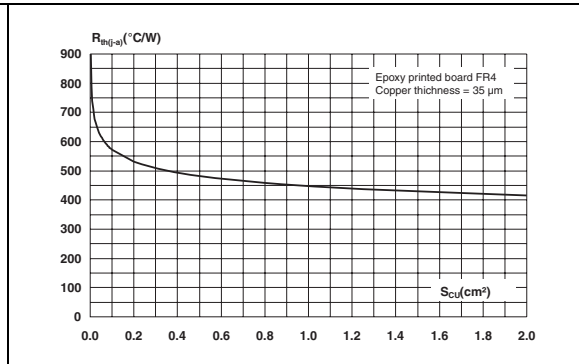
**Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration**



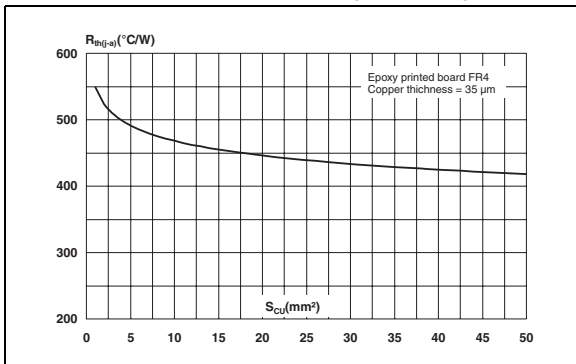
**Figure 7. Relative variation of thermal impedance junction to ambient versus pulse duration**



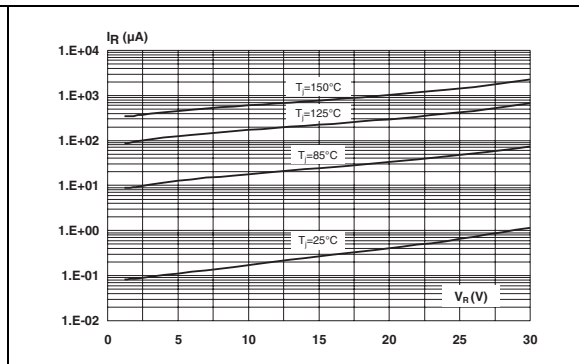
**Figure 8. Thermal resistance junction to ambient versus copper surface under each lead (SOD-923)**



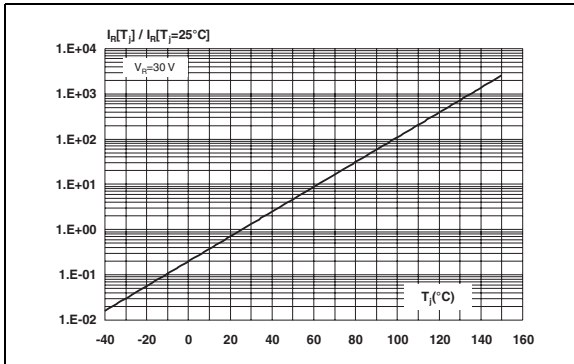
**Figure 9. Thermal resistance junction to ambient versus copper surface under each lead (SOD-323)**



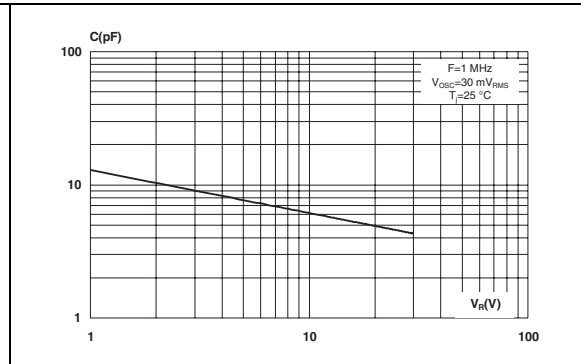
**Figure 10. Leakage current versus reverse applied voltage (typical values)**



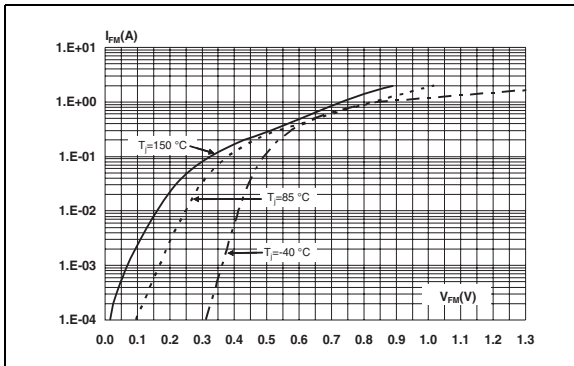
**Figure 11. Relative variation of reverse leakage current versus junction temperature (typical values)**



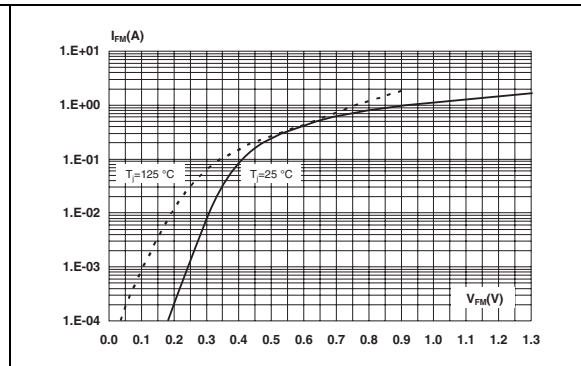
**Figure 12. Junction capacitance versus reverse applied voltage (typical values)**



**Figure 13. Forward voltage drop versus forward current (typical values)**

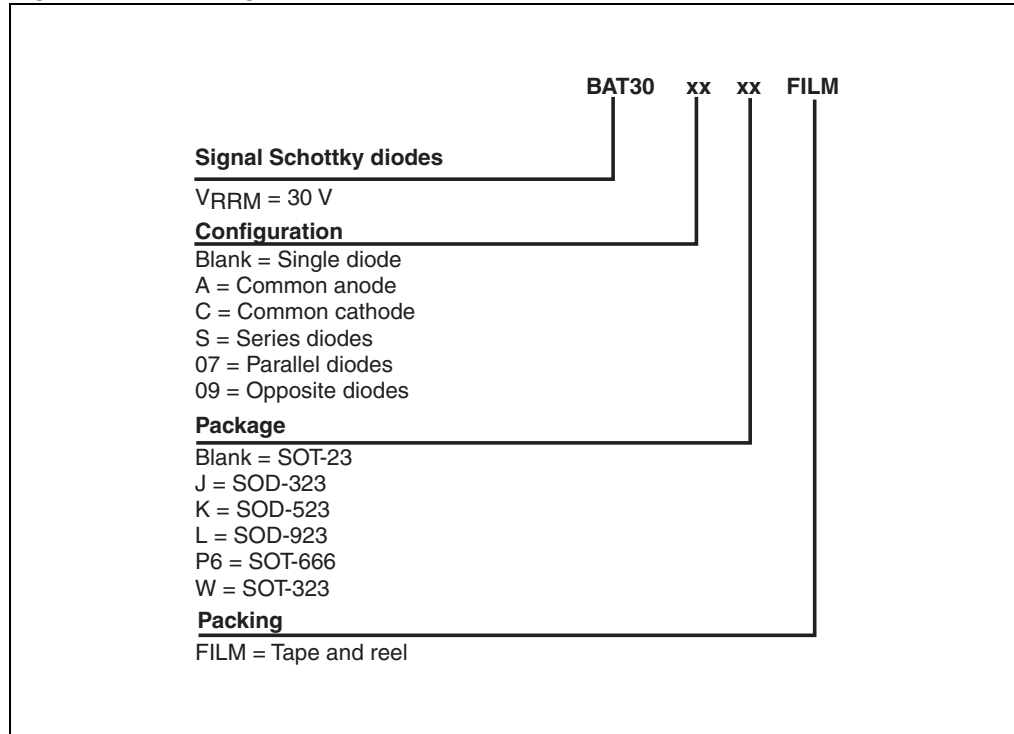


**Figure 14. Forward voltage drop versus forward current (typical values)**



## 2 Ordering information scheme

Figure 15. Ordering information scheme



### 3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

**Table 6. SOD-323 dimensions**

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	-	1.17	-	0.046
A1	0	0.1	0	0.004
b	0.25	0.44	0.01	0.017
c	0.1	0.25	0.004	0.01
D	1.52	1.8	0.06	0.071
E	1.11	1.45	0.044	0.057
H	2.3	2.7	0.09	0.106
L	0.1	0.46	0.004	0.02
Q1	0.1	0.41	0.004	0.016

**Figure 16. SOD-323 footprint (dimensions in mm)**

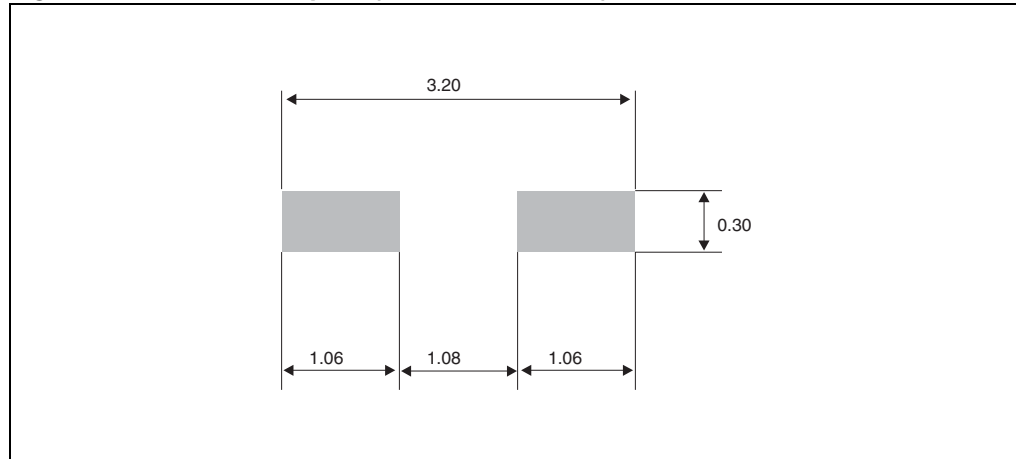


Table 7. SOD-523 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.50	0.60	0.70	0.020	0.024	0.028
E	1.50	1.60	1.70	0.059	0.063	0.067
E1	1.10	1.20	1.30	0.043	0.047	0.051
D	0.70	0.80	0.90	0.028	0.031	0.035
b	0.25	-	0.35	0.010	-	0.014
c	0.07	-	0.20	0.003	-	0.008
L	0.15	0.20	0.25	0.006	0.008	0.010
L1	0.05	-	0.20	0.002	-	0.008

Figure 17. SOD-523 footprint (dimensions in mm)

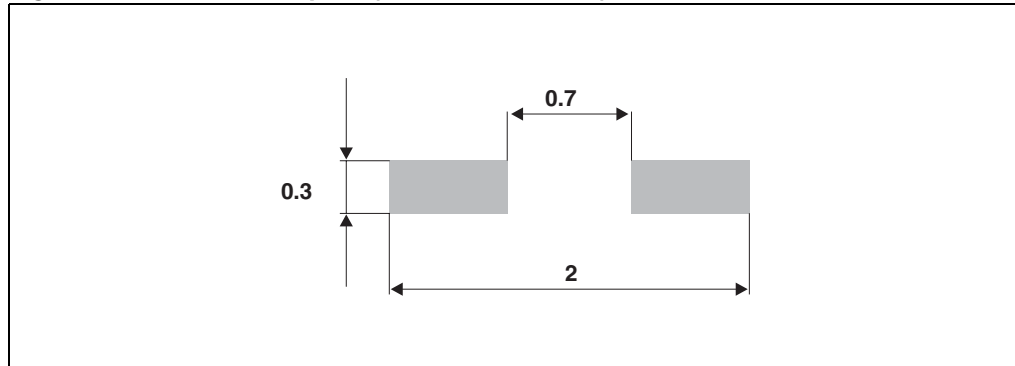




Table 8. SOD-923 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			0.40			0.016
b	0.25	0.30	0.35	0.010	0.012	0.014
c	0.08	0.145	0.21	0.003	0.006	0.008
D	0.55	0.60	0.65	0.022	0.024	0.026
E	0.95	1.00	1.05	0.037	0.039	0.041
E1	0.75	0.825	0.90	0.030	0.032	0.035
L	-	-	0.20	-	-	0.008

Figure 18. SOD-923 footprint (dimensions in mm)

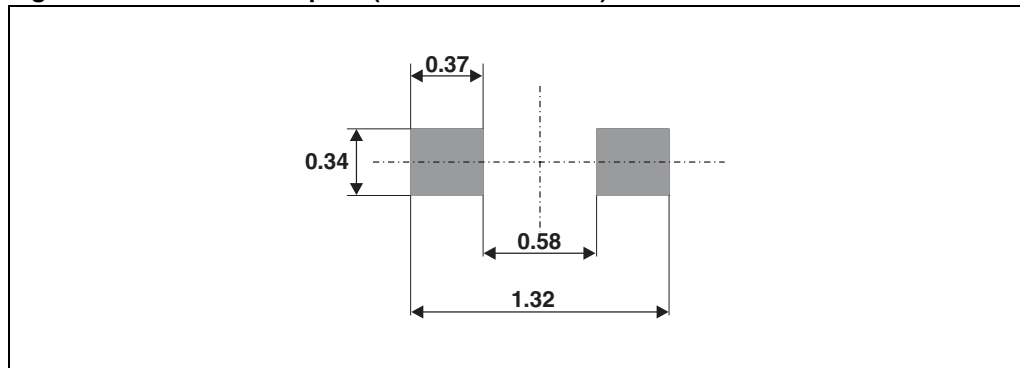


Table 9. SOT-23 dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
c	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.6	0.047	0.063
H	2.1	2.75	0.083	0.108
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.014	0.026

Figure 19. SOT-23 footprint (dimensions in mm)

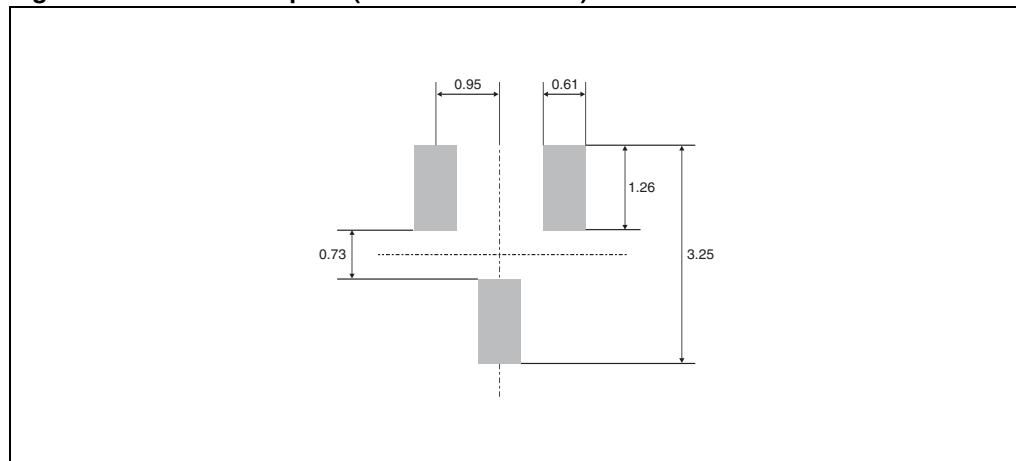


Table 10. SOT-323 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.8	-	1.1	0.031	-	0.043
A1	0.0	-	0.1	0.0	-	0.004
b	0.25	-	0.4	0.010	-	0.016
c	0.1	-	0.26	0.004	-	0.010
D	1.8	2.0	2.2	0.071	0.079	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	-	0.65	-	-	0.026	-
H	1.8	2.1	2.4	0.071	0.083	0.094
L	0.1	0.2	0.3	0.004	0.008	0.012
q	0	-	30°	0	-	30°

Figure 20. SOT-323 footprint (dimensions in mm)

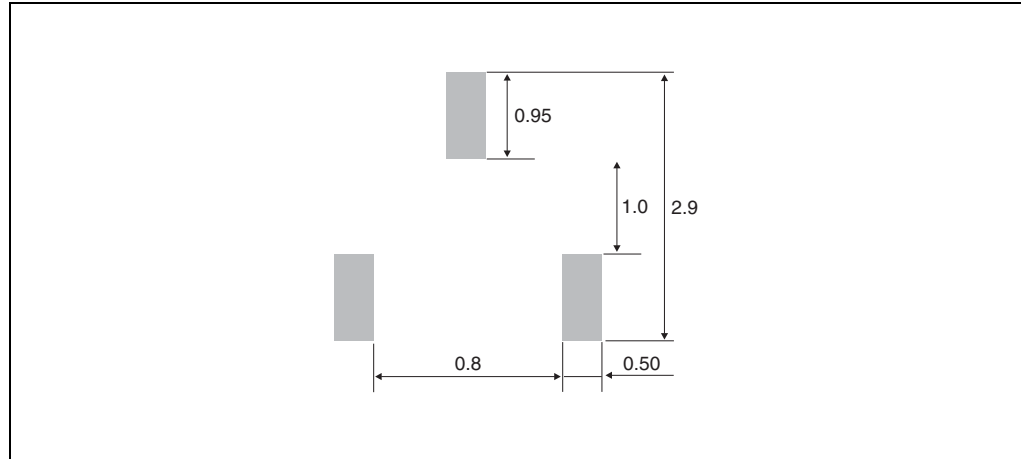
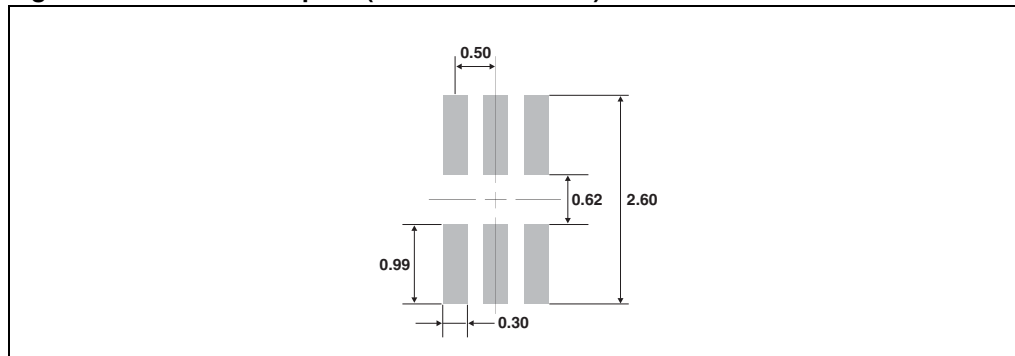


Table 11. SOT-666 dimensions

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.45	-	0.60	0.018	-	0.024
A3	0.08	-	0.18	0.003	-	0.007
b	0.17	-	0.34	0.007	-	0.013
b1	0.19	0.27	0.34	0.007	0.011	0.013
D	1.50	-	1.70	0.059	-	0.067
E	1.50	-	1.70	0.059	-	0.067
E1	1.10	-	1.30	0.043	-	0.051
e	-	0.50	-	-	0.020	-
L1	-	0.19	-	-	0.007	-
L2	0.10	-	0.30	0.004	-	0.012
L3	-	0.10	-	-	0.004	-

Figure 21. SOT-666 footprint (dimensions in mm)



## 4 Ordering information

Table 12. Ordering information

Order code	Marking	Package	Weight	Base qty	Packing mode
BAT30-07P6FILM	P3	SOT-666 Parallel	2.9 mg	5000	Tape and reel
BAT30-09P6FILM	Q3	SOT-666 Opposite	2.9 mg	5000	Tape and reel
BAT30AFILM	A30	SOT-23 Common anode	10 mg	3000	Tape and reel
BAT30AWFILM	A30	SOT-323 Common anode	6 mg	3000	Tape and reel
BAT30CFILM	C30	SOT-23 Common cathode	10 mg	3000	Tape and reel
BAT30CWFILM	C30	SOT-323 Common cathode	6 mg	3000	Tape and reel
BAT30FILM	B30	SOT-23 Single	10 mg	3000	Tape and reel
BAT30JFILM	30	SOD-323 Single	5 mg	3000	Tape and reel
BAT30KFILM	30	SOD-523 Single	1.4 mg	3000	Tape and reel
BAT30LFILM	31	SOD-923 Single	0.56 mg	10000	Tape and reel
BAT30SFILM	S30	SOT-23 Serial	10 mg	3000	Tape and reel
BAT30SWFILM	S30	SOT-323 Serial	6 mg	3000	Tape and reel
BAT30WFILM	B30	SOT-323 Single	6 mg	3000	Tape and reel

## 5 Revision history

Table 13. Document revision history

Date	Revision	Changes
24-Jul-2006	1	First issue
08-Jul-2009	2	Added SOD-923 package. Table 12 sorted on alphabetic sequence of order code. Updated ECOPACK statement.
13-Oct-2009	3	Updated Table 7 quote "L1" from 0.10 to 0.05.

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